

2SB0956 (2SB956)

Silicon PNP epitaxial planer type

For low-frequency power amplification

Complementary to 2SD1280

Features

- Large collector power dissipation P_C .
- Low collector to emitter saturation voltage $V_{CE(sat)}$.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-20	V
Collector to emitter voltage	V_{CEO}	-20	V
Emitter to base voltage	V_{EBO}	-5	V
Peak collector current	I_{CP}	-2	A
Collector current	I_C	-1	A
Collector power dissipation	P_C^*	1	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

* Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion

Electrical Characteristics (Ta=25°C)

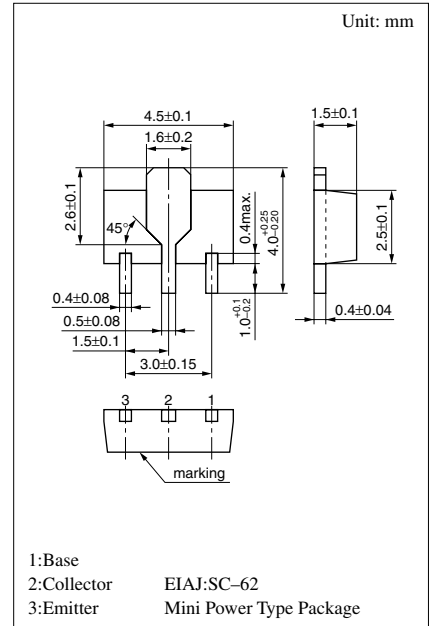
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -10V, I_E = 0$			-1	μA
Collector to emitter voltage	V_{CEO}	$I_C = -1mA, I_B = 0$	-20			V
Emitter to base voltage	V_{EBO}	$I_E = -10μA, I_C = 0$	-5			V
Forward current transfer ratio	h_{FE1}^{*1}	$V_{CE} = -2V, I_C = -500mA^{*2}$	130		280	
	h_{FE2}	$V_{CE} = -2V, I_C = -1.5A^{*2}$	50			
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -1A, I_B = -50mA^{*2}$			-0.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = -500mA, I_B = -50mA$			-1.2	V
Transition frequency	f_T	$V_{CB} = -6V, I_E = 50mA, f = 200MHz$		200		MHz
Collector output capacitance	C_{ob}	$V_{CB} = -6V, I_E = 0, f = 1MHz$		40		pF

*2 Pulse measurement

*1 h_{FE1} Rank classification

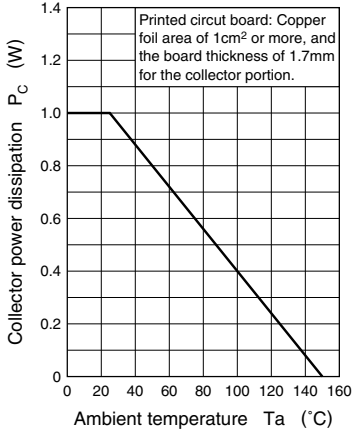
Rank	R	S
h_{FE1}	130 ~ 210	180 ~ 280
Marking Symbol	HR	HS

Note.) The Part number in the Parenthesis shows conventional part number.

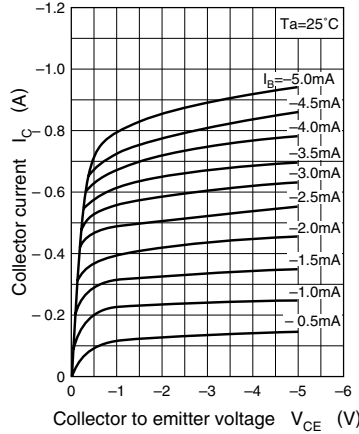


Marking symbol : H

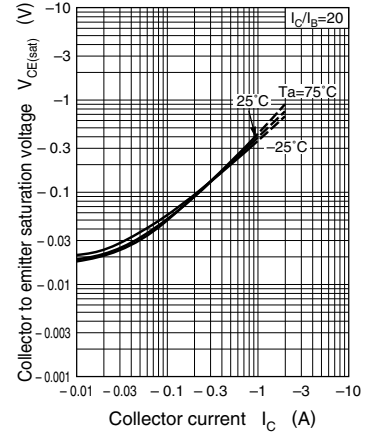
$P_C - T_a$



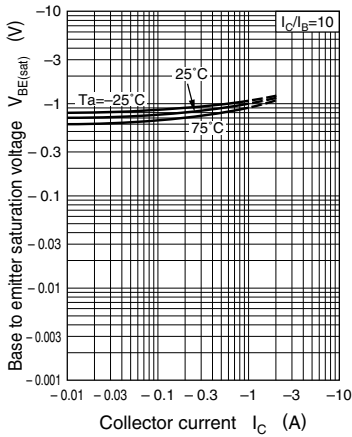
$I_C - V_{CE}$



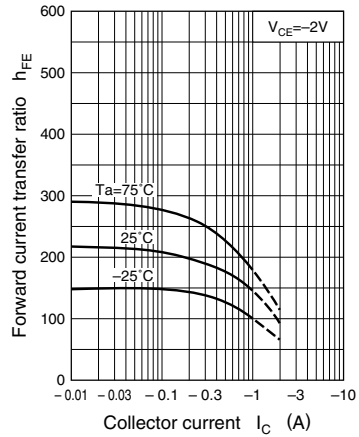
$V_{CE(sat)} - I_C$



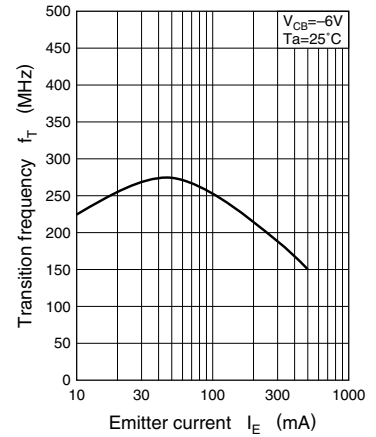
$V_{BE(sat)} - I_C$



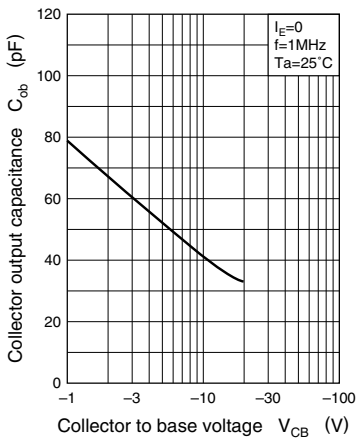
$h_{FE} - I_C$



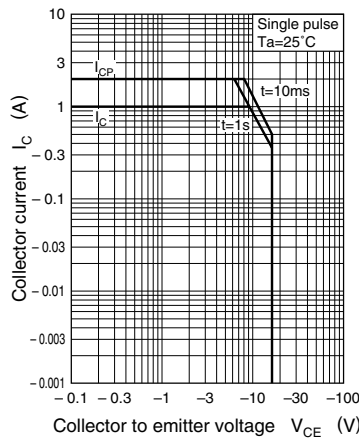
$f_T - I_E$



$C_{ob} - V_{CB}$



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